



# VN750 / VN750S VN750PT / VN750-B5

## HIGH SIDE DRIVER

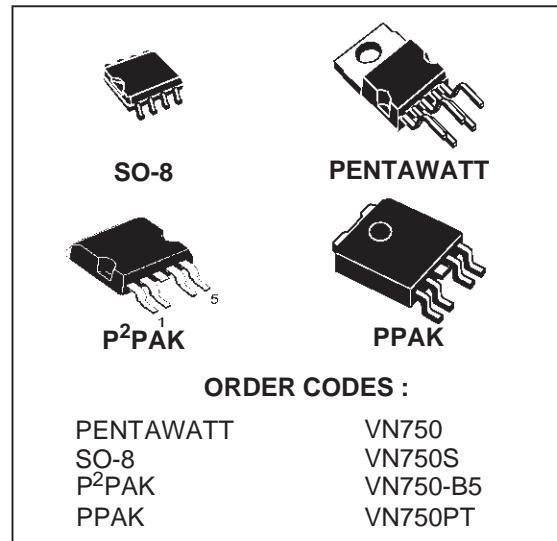
TYPE	R <sub>DS(on)</sub>	I <sub>OUT</sub>	V <sub>CC</sub>
VN750			
VN750S	60 mΩ	6 A	36 V
VN750PT			
VN750-B5			

- CMOS COMPATIBLE INPUT
- ON STATE OPEN LOAD DETECTION
- OFF STATE OPEN LOAD DETECTION
- SHORTED LOAD PROTECTION
- UNDervoltage AND OVERVOLTAGE SHUTDOWN
- PROTECTION AGAINST LOSS OF GROUND
- VERY LOW STAND-BY CURRENT
- REVERSE BATTERY PROTECTION (\*)

### DESCRIPTION

The VN750, VN750S, VN750PT, VN750-B5 are a monolithic device designed in STMicroelectronics VIPower M0-3 Technology, intended for driving any kind of load with one side connected to ground.

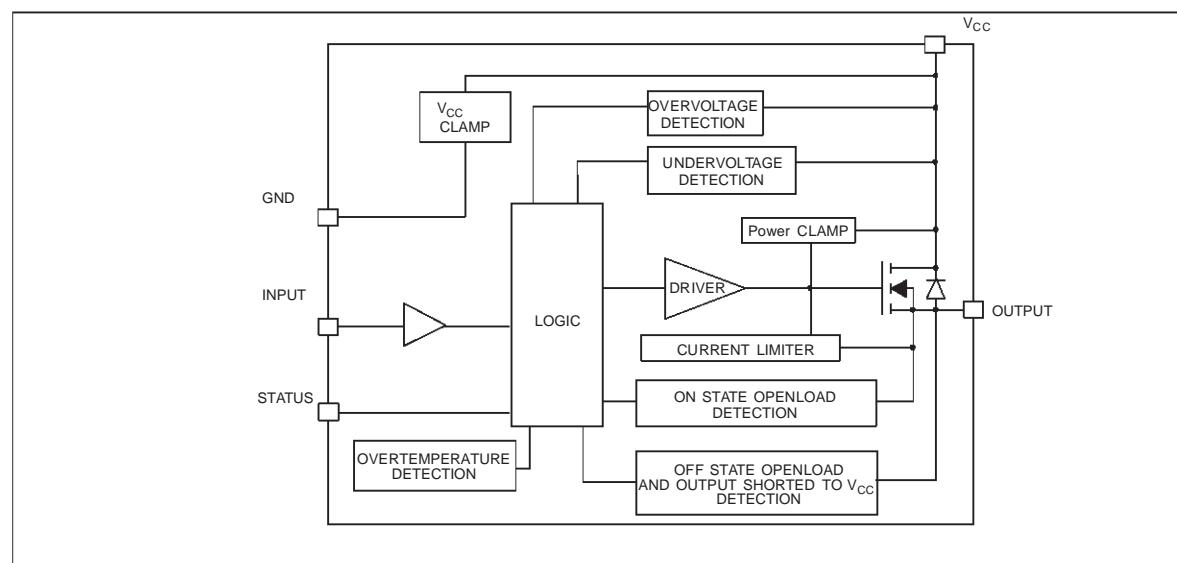
Active V<sub>CC</sub> pin voltage clamp protects the device against low energy spikes (see ISO7637 transient



compatibility table). Active current limitation combined with thermal shutdown and automatic restart protect the device against overload.

The device detects open load condition both in on and off state. Output shorted to V<sub>CC</sub> is detected in the off state. Device automatically turns off in case of ground pin disconnection.

### BLOCK DIAGRAM



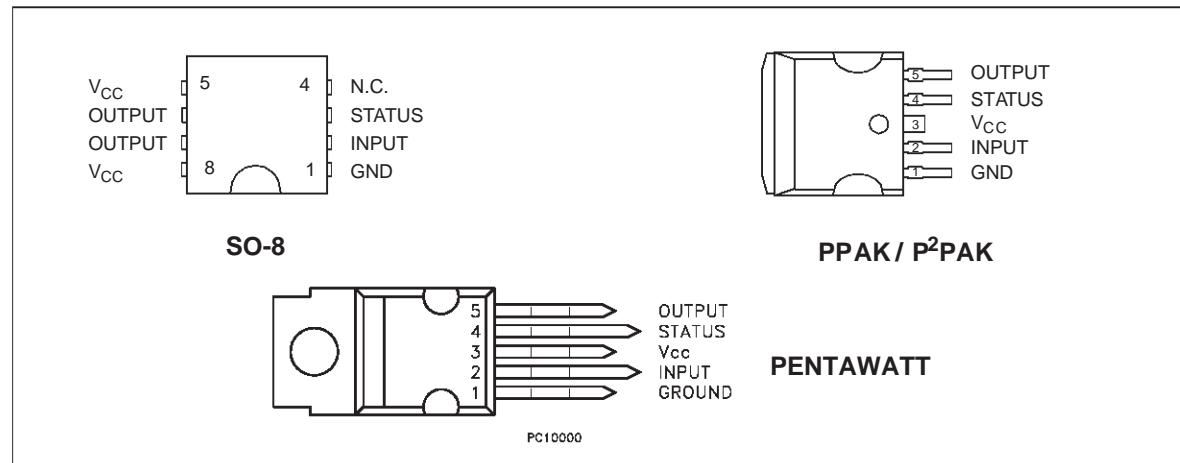
(\*) See application schematic at page 8

## VN750 / VN750S / VN750PT / VN750-B5

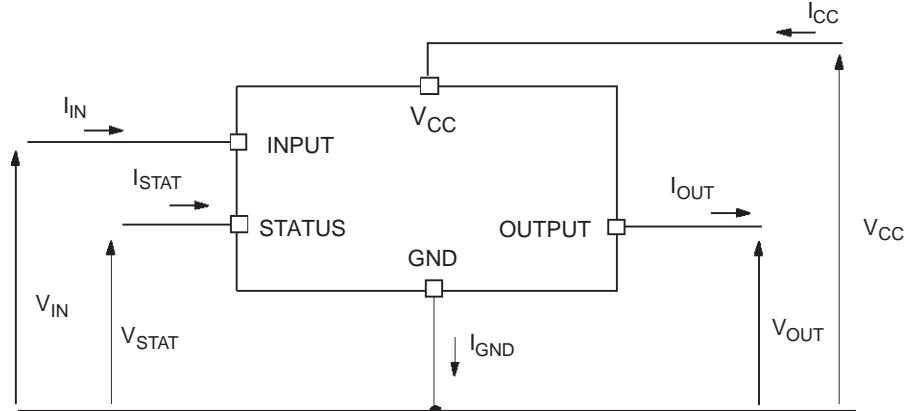
### ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value				Unit
		SO-8	PENTAWATT	P <sup>2</sup> PAK	PPAK	
$V_{CC}$	DC Supply Voltage		41			V
$-V_{CC}$	Reverse DC Supply Voltage		- 0.3			V
$-I_{GND}$	DC Reverse Ground Pin Current		- 200			mA
$I_{OUT}$	DC Output Current		Internally Limited			A
$-I_{OUT}$	Reverse DC Output Current		- 6			A
$I_{IN}$	DC Input Current		+/- 10			mA
$I_{STAT}$	DC Status Current		+/- 10			mA
$V_{ESD}$	Electrostatic Discharge ( $R=1.5\text{ k}\Omega$ ; $C=100\text{ pF}$ )		2000			V
$P_{tot}$	Power Dissipation $T_C=25^\circ\text{C}$	4.2	42	42	42	W
$T_j$	Junction Operating Temperature		Internally Limited			$^\circ\text{C}$
$T_c$	Case Operating Temperature		- 40 to 150			$^\circ\text{C}$
$T_{stg}$	Storage Temperature		- 55 to 150			$^\circ\text{C}$

### CONNECTION DIAGRAM (TOP VIEW)



### CURRENT AND VOLTAGE CONVENTIONS



### **THERMAL DATA**

<b>Symbol</b>	<b>Parameter</b>	<b>Value</b>				<b>Unit</b>	
		<b>S0-8</b>	<b>PENTAWATT</b>	<b>P<sup>2</sup>PAK</b>	<b>PPAK</b>		
$R_{thj\text{-case}}$	Thermal Resistance Junction-case	Max	-	3	3	3	$^{\circ}\text{C/W}$
$R_{thj\text{-lead}}$	Thermal Resistance Junction-lead	Max	30	-	-	-	$^{\circ}\text{C/W}$
$R_{thj\text{-amb}}$	Thermal Resistance Junction-ambient	Max	80 (*)	60 (**)	53 (**)	53 (**)	$^{\circ}\text{C/W}$

(\*) When mounted on a standard single-sided FR-4 board with 50mm<sup>2</sup> of Cu (at least 35 $\mu\text{m}$  thick) connected to all V<sub>CC</sub> pins.

(\*\*) When mounted on a standard single-sided FR-4 board with 50mm<sup>2</sup> of Cu (at least 35 $\mu\text{m}$  thick).

### **ELECTRICAL CHARACTERISTICS (8V < V<sub>CC</sub> < 36V; -40°C < T<sub>j</sub> < 150°C unless otherwise specified)**

#### **POWER**

<b>Symbol</b>	<b>Parameter</b>	<b>Test Conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
V <sub>CC</sub>	Operating Supply Voltage		5.5	13	36	V
V <sub>USD</sub>	Undervoltage Shut-down		3	4	5.5	V
V <sub>USDhyst</sub>	Undervoltage Shut-down Hysteresis			0.5		V
V <sub>OV</sub>	Overtoltage Shut-down		36	42	48	V
R <sub>ON</sub>	On State Resistance	I <sub>OUT</sub> =2A; T <sub>j</sub> =25°C; V <sub>CC</sub> >8V I <sub>OUT</sub> =2A; V <sub>CC</sub> >8V		(*)	60 120	m $\Omega$ m $\Omega$
I <sub>S</sub>	Supply Current	Off State; V <sub>CC</sub> =13V; V <sub>IN</sub> =V <sub>OUT</sub> =0V Off State; V <sub>CC</sub> =13V; V <sub>IN</sub> =V <sub>OUT</sub> =0V; T <sub>j</sub> =25°C On State; V <sub>CC</sub> =13V; V <sub>IN</sub> =5V; I <sub>OUT</sub> =0A		10 10 2	25 20 3.5	$\mu\text{A}$ $\mu\text{A}$ mA
I <sub>L(off1)</sub>	Off State Output Current	V <sub>IN</sub> =V <sub>OUT</sub> =0V	0	(*)	50	$\mu\text{A}$
I <sub>L(off2)</sub>	Off State Output Current	V <sub>IN</sub> =0V; V <sub>OUT</sub> =3.5V	-75		0	$\mu\text{A}$

#### **SWITCHING (V<sub>CC</sub>=13V)**

<b>Symbol</b>	<b>Parameter</b>	<b>Test Conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
t <sub>d(on)</sub>	Turn-on Delay Time	R <sub>L</sub> =6.5 $\Omega$ from V <sub>IN</sub> rising edge to V <sub>OUT</sub> =1.3V		40		$\mu\text{s}$
t <sub>d(off)</sub>	Turn-off Delay Time	R <sub>L</sub> =6.5 $\Omega$ from V <sub>IN</sub> falling edge to V <sub>OUT</sub> =11.7V		30		$\mu\text{s}$
dV <sub>OUT</sub> /dt <sub>(on)</sub>	Turn-on Voltage Slope	R <sub>L</sub> =6.5 $\Omega$ from V <sub>OUT</sub> =1.3V to V <sub>OUT</sub> =10.4V		(*)		V/ $\mu\text{s}$
dV <sub>OUT</sub> /dt <sub>(off)</sub>	Turn-off Voltage Slope	R <sub>L</sub> =6.5 $\Omega$ from V <sub>OUT</sub> =11.7V to V <sub>OUT</sub> =1.3V		(*)		V/ $\mu\text{s}$

#### **INPUT PIN**

<b>Symbol</b>	<b>Parameter</b>	<b>Test Conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
V <sub>IL</sub>	Input Low Level			(*)	1.25	V
I <sub>IL</sub>	Low Level Input Current	V <sub>IN</sub> =1.25V	1	(*)		$\mu\text{A}$
V <sub>IH</sub>	Input High Level		3.25	(*)		V
I <sub>IH</sub>	High Level Input Current	V <sub>IN</sub> =3.25V		(*)	10	$\mu\text{A}$
V <sub>hyst</sub>	Input Hysteresis Voltage		0.5	(*)		V
V <sub>ICL</sub>	Input Clamp Voltage	I <sub>IN</sub> =1mA I <sub>IN</sub> =-1mA	6	6.8 -0.7	8	V V

(\*) See curves at pages 9, 10, 11

## VN750 / VN750S / VN750PT / VN750-B5

### ELECTRICAL CHARACTERISTICS (continued)

#### STATUS PIN

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{STAT}$	Status Low Output Voltage	$I_{STAT}=1.6\text{mA}$		(*)	0.5	V
$I_{LSTAT}$	Status Leakage Current	Normal Operation; $V_{STAT}=5\text{V}$		(*)	10	$\mu\text{A}$
$C_{STAT}$	Status Pin Input Capacitance	Normal Operation; $V_{STAT}=5\text{V}$			100	pF
$V_{SCL}$	Status Clamp Voltage	$I_{STAT}=1\text{mA}$ $I_{STAT}=-1\text{mA}$	6	6.8 -0.7	8	V V

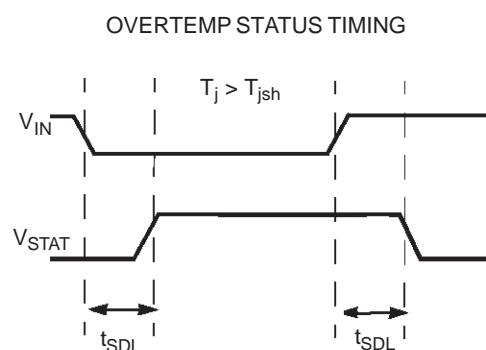
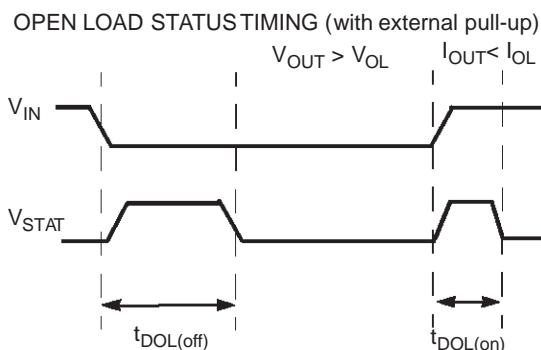
#### PROTECTIONS

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$T_{TSD}$	Shut-down Temperature		150	175	200	$^{\circ}\text{C}$
$T_R$	Reset Temperature		135			$^{\circ}\text{C}$
$T_{hyst}$	Thermal Hysteresis		7	15		$^{\circ}\text{C}$
$t_{SDL}$	Status delay in overload condition	$T_j > T_{jsh}$			20	$\mu\text{s}$
$I_{lim}$	Current limitation	$9\text{V} < V_{CC} < 36\text{V}$ $5\text{V} < V_{CC} < 36\text{V}$	6	9 15	15	A A
$V_{demag}$	Turn-off Output Clamp Voltage	$I_{OUT}=2\text{A}$ ; $V_{IN}=0\text{V}$ ; $L=6\text{mH}$	$V_{CC}-41$	$V_{CC}-48$	$V_{CC}-55$	V

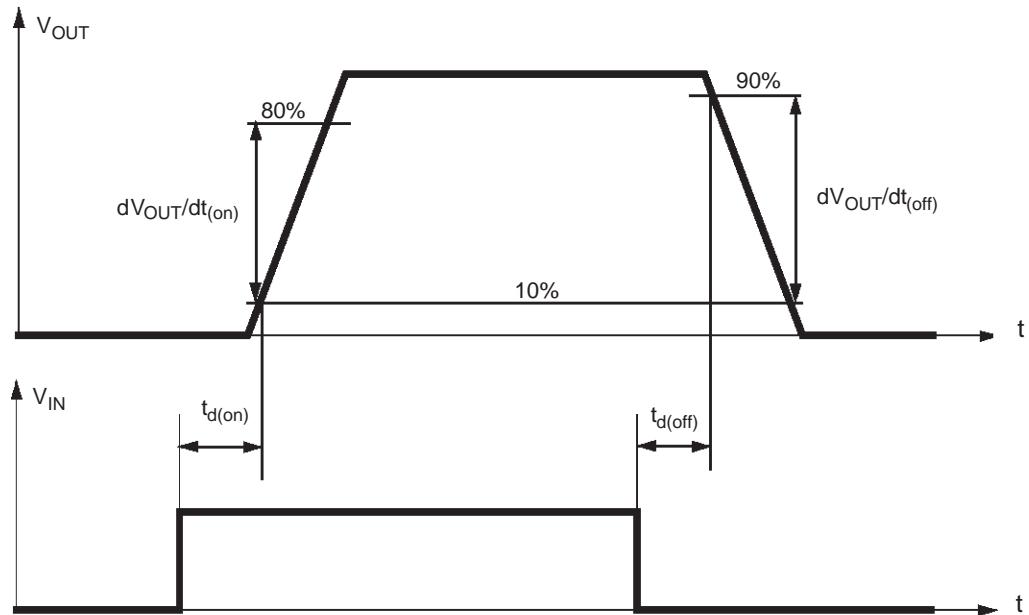
#### OPENLOAD DETECTION

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$I_{OL}$	Openload ON State Detection Threshold	$V_{IN}=5\text{V}$	50	(*)	200	mA
$t_{DOL(on)}$	Openload ON State Detection Delay	$I_{OUT}=0\text{A}$			200	$\mu\text{s}$
$V_{OL}$	Openload OFF State Voltage Detection Threshold	$V_{IN}=0\text{V}$	1.5	(*)	3.5	V
$t_{DOL(off)}$	Openload Detection Delay at Turn Off				1000	$\mu\text{s}$

(\*) See curves at pages 9, 10, 11



**Switching time Waveforms**



**TRUTH TABLE**

CONDITIONS	INPUT	OUTPUT	STATUS
Normal Operation	L H	L H	H H
Current Limitation	L H	L X	H H
Overtemperature	L H	L L	H L
Undervoltage	L H	L L	X X
Overvoltage	L H	L L	H H
Output Voltage > $V_{OL}$	L H	H H	L H
Output Current < $I_{OL}$	L H	L H	H L

## VN750 / VN750S / VN750PT / VN750-B5

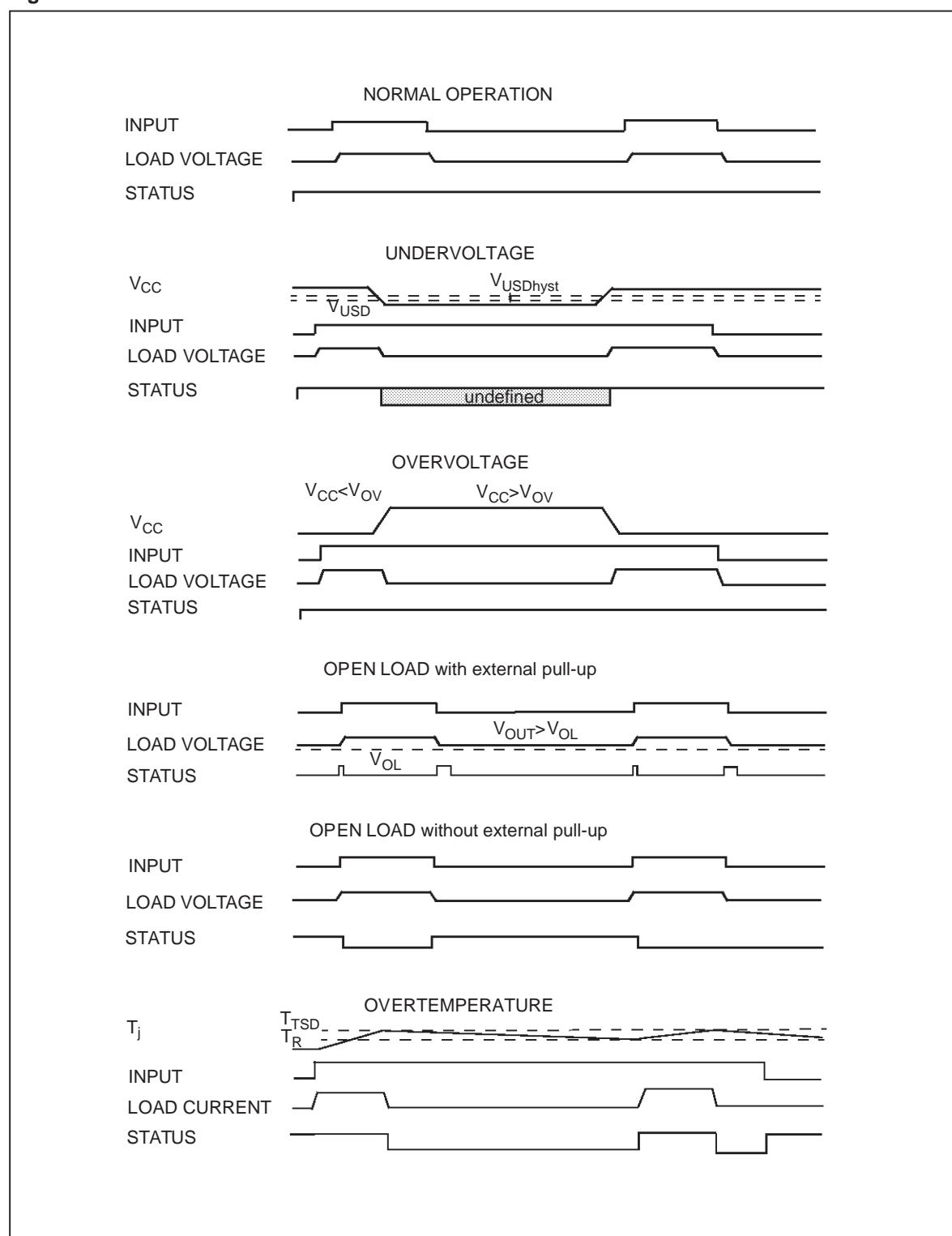
### ELECTRICAL TRANSIENT REQUIREMENTS ON V<sub>CC</sub> PIN

ISO T/R 7637/1 Test Pulse	TEST LEVELS				
	I	II	III	IV	Delays and Impedance
1	-25 V	-50 V	-75 V	-100 V	2 ms 10 Ω
2	+25 V	+50 V	+75 V	+100 V	0.2 ms 10 Ω
3a	-25 V	-50 V	-100 V	-150 V	0.1 μs 50 Ω
3b	+25 V	+50 V	+75 V	+100 V	0.1 μs 50 Ω
4	-4 V	-5 V	-6 V	-7 V	100 ms, 0.01 Ω
5	+26.5 V	+46.5 V	+66.5 V	+86.5 V	400 ms, 2 Ω

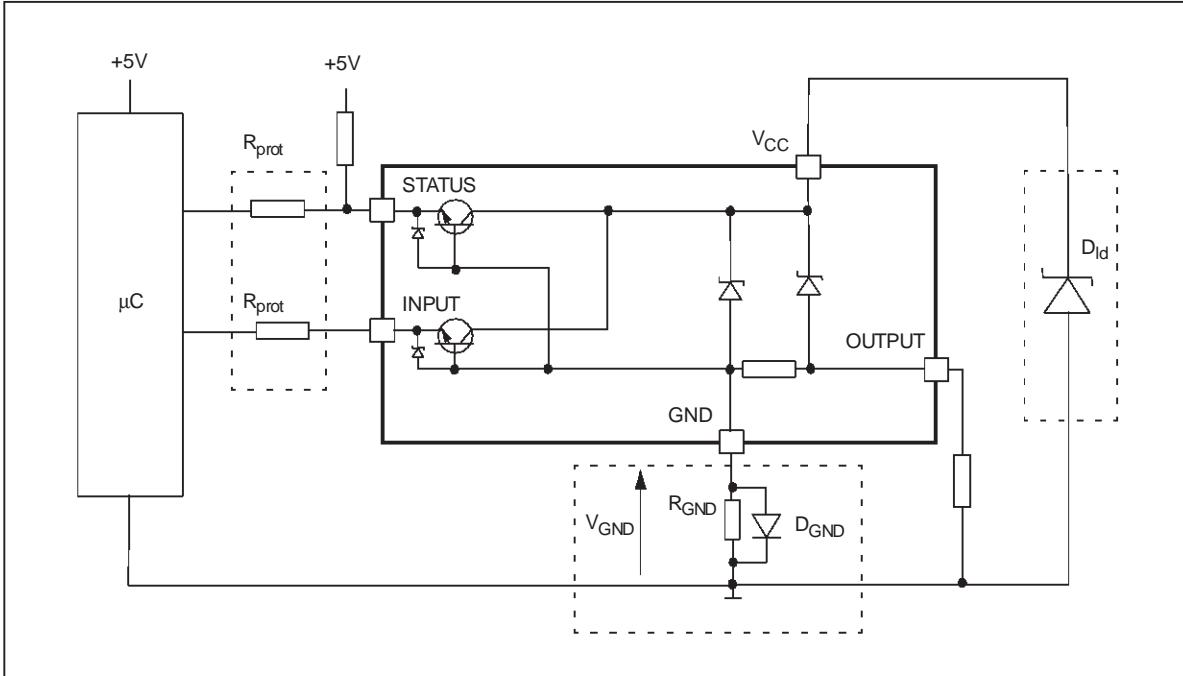
ISO T/R 7637/1 Test Pulse	TEST LEVELS RESULTS			
	I	II	III	IV
1	C	C	C	C
2	C	C	C	C
3a	C	C	C	C
3b	C	C	C	C
4	C	C	C	C
5	C	E	E	E

CLASS	CONTENTS
C	All functions of the device are performed as designed after exposure to disturbance.
E	One or more functions of the device is not performed as designed after exposure to disturbance and cannot be returned to proper operation without replacing the device.

**Figure1: Waveforms**



## APPLICATION SCHEMATIC



### GND PROTECTION NETWORK AGAINST REVERSE BATTERY

Solution 1: Resistor in the ground line ( $R_{GND}$  only). This can be used with any type of load.

The following is an indication on how to dimension the  $R_{GND}$  resistor.

- 1)  $R_{GND} \leq 600\text{mV} / (I_{S(on)\max})$ .
- 2)  $R_{GND} \geq (-V_{CC}) / (-I_{GND})$

where  $-I_{GND}$  is the DC reverse ground pin current and can be found in the absolute maximum rating section of the device's datasheet.

Power Dissipation in  $R_{GND}$  (when  $V_{CC} < 0$ : during reverse battery situations) is:

$$P_D = (-V_{CC})^2 / R_{GND}$$

This resistor can be shared amongst several different HSD. Please note that the value of this resistor should be calculated with formula (1) where  $I_{S(on)\max}$  becomes the sum of the maximum on-state currents of the different devices.

Please note that if the microprocessor ground is not common with the device ground then the  $R_{GND}$  will produce a shift ( $I_{S(on)\max} * R_{GND}$ ) in the input thresholds and the status output values. This shift will vary depending on many devices are ON in the case of several high side drivers sharing the same  $R_{GND}$ .

If the calculated power dissipation leads to a large resistor or several devices have to share the same resistor then the ST suggests to utilize Solution 2 (see below).

Solution 2: A diode ( $D_{GND}$ ) in the ground line.

A resistor ( $R_{GND}=1\text{k}\Omega$ ) should be inserted in parallel to  $D_{GND}$  if the device will be driving an inductive load.

This small signal diode can be safely shared amongst several different HSD. Also in this case, the presence of the ground network will produce a shift ( $\pm 600\text{mV}$ ) in the input threshold and the status output values if the microprocessor ground is not common with the device ground. This shift will not vary if more than one HSD shares the same diode/resistor network.

### LOAD DUMP PROTECTION

$D_{ld}$  is necessary (Transil or MOV) if the load dump peak voltage exceeds  $V_{CC}$  max DC rating. The same applies if the device will be subject to transients on the  $V_{CC}$  line that are greater than the ones shown in the ISO T/R 7637/1 table.

### μC I/Os PROTECTION:

If a ground protection network is used and negative transients are present on the  $V_{CC}$  line, the control pins will be pulled negative. ST suggests to insert a resistor ( $R_{prot}$ ) in line to prevent the  $\mu\text{C}$  I/Os pins to latch-up.

The value of these resistors is a compromise between the leakage current of  $\mu\text{C}$  and the current required by the HSD I/Os (Input levels compatibility) with the latch-up limit of  $\mu\text{C}$  I/Os.

$$-V_{CCpeak} / I_{latchup} \leq R_{prot} \leq (V_{OH\mu\text{C}} - V_{IH} - V_{GND}) / I_{IH\max}$$

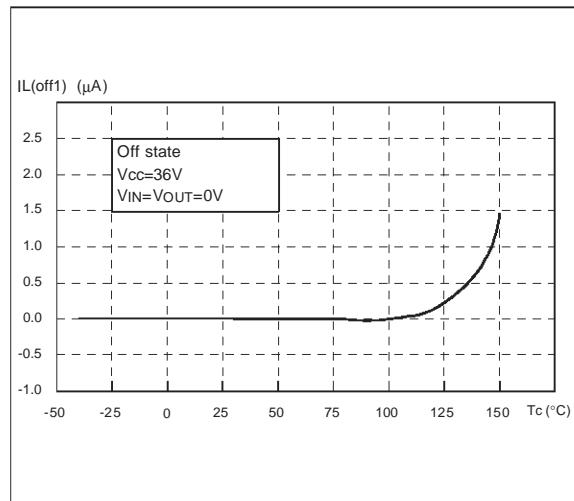
Calculation example:

For  $V_{CCpeak} = -100\text{V}$  and  $I_{latchup} \geq 20\text{mA}$ ;  $V_{OH\mu\text{C}} \geq 4.5\text{V}$   
 $5\text{k}\Omega \leq R_{prot} \leq 65\text{k}\Omega$ .

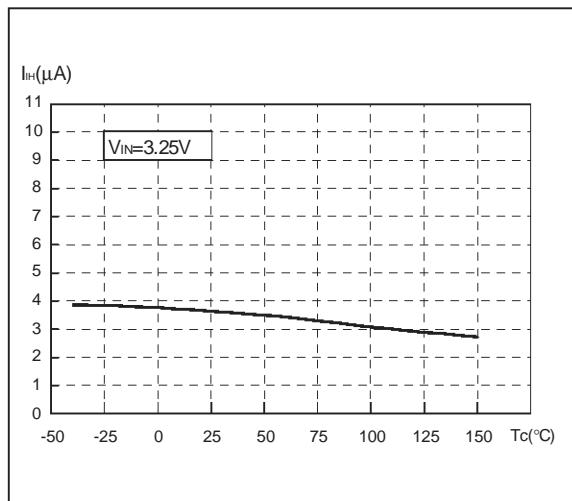
Recommended  $R_{prot}$  value is  $10\text{k}\Omega$ .

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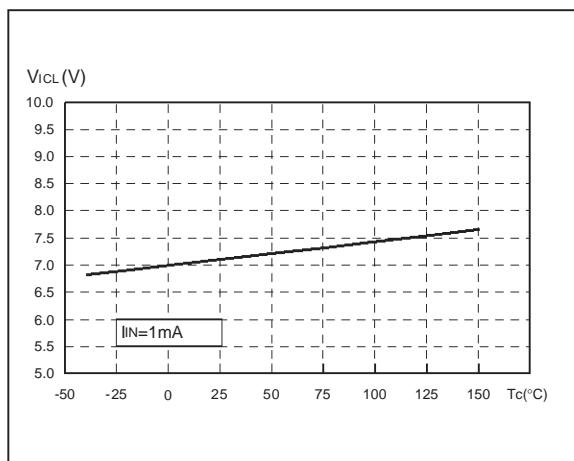
Off State Output Current



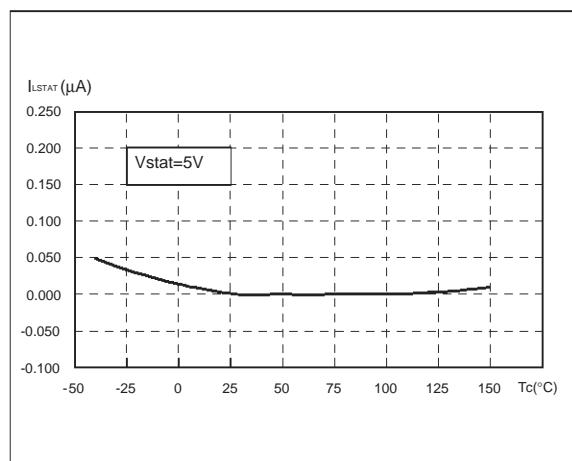
High Level Input Current



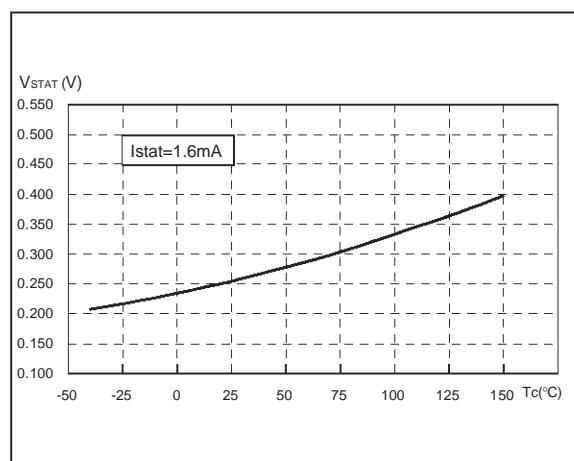
Input Clamp Voltage



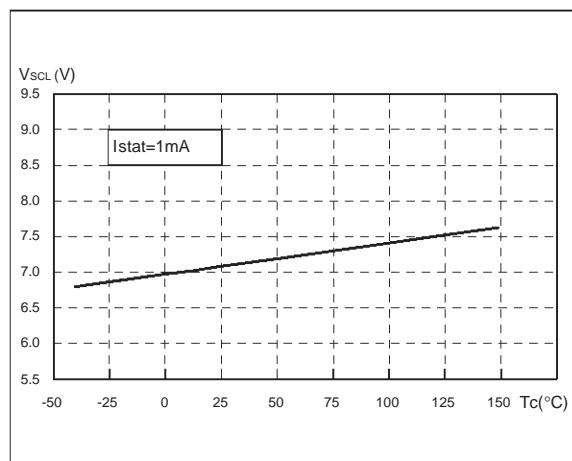
Status Leakage Current



Status Low Output Voltage

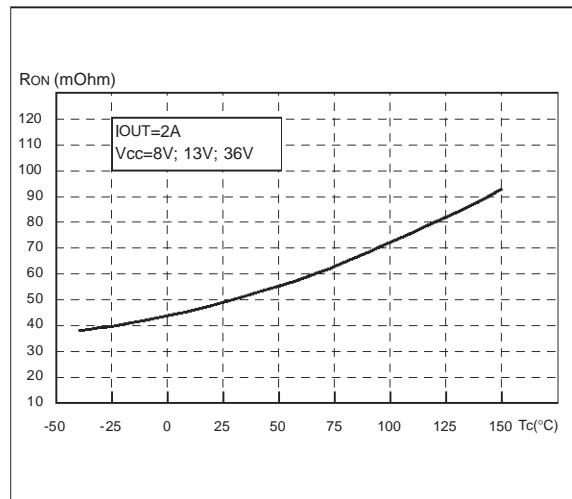


Status Clamp Voltage

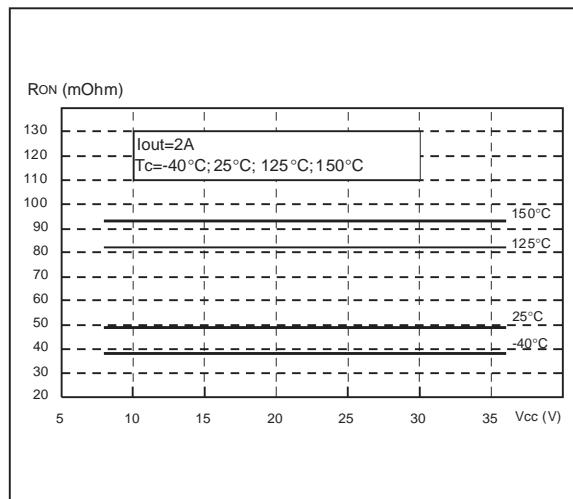


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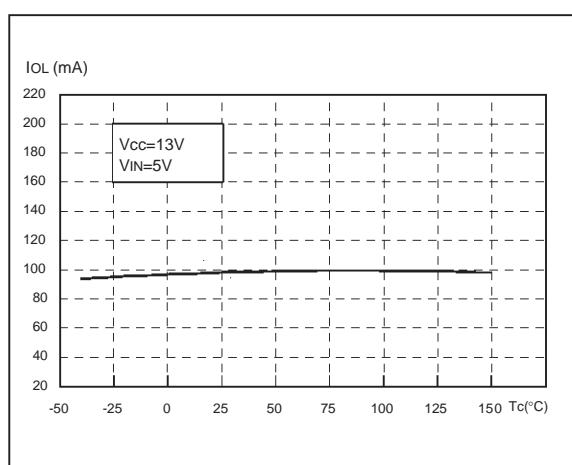
On State Resistance Vs  $T_{case}$



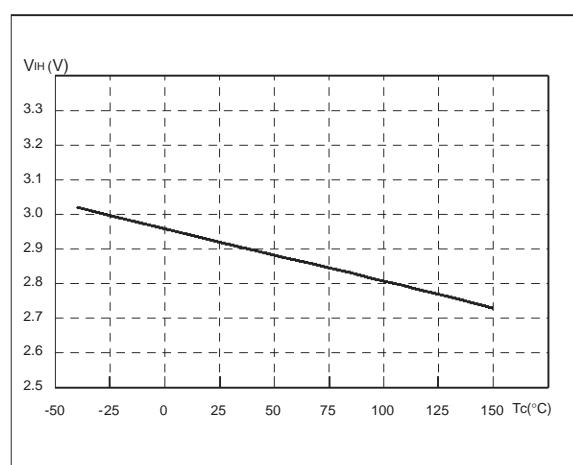
On State Resistance Vs  $V_{CC}$



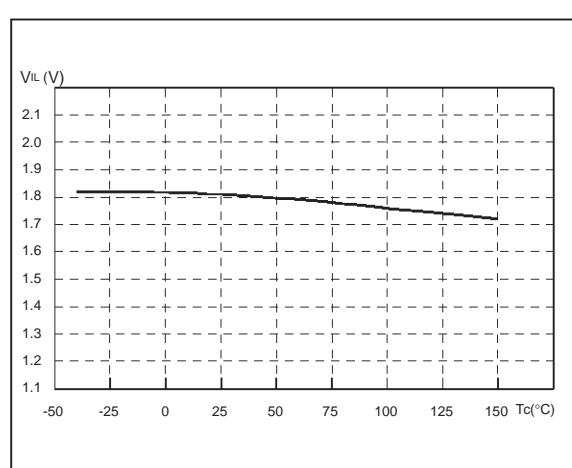
Openload On State Detection Threshold



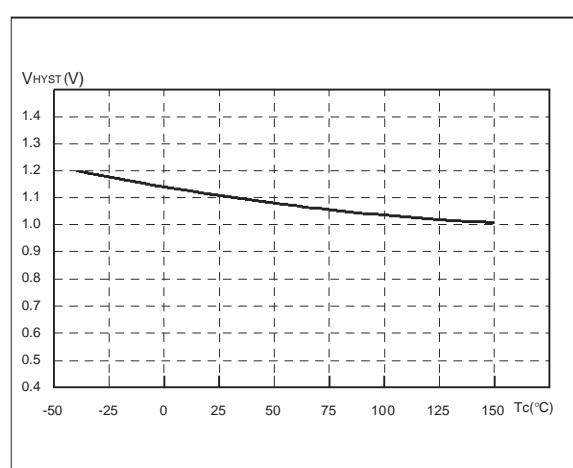
Input High Level



Input Low Level

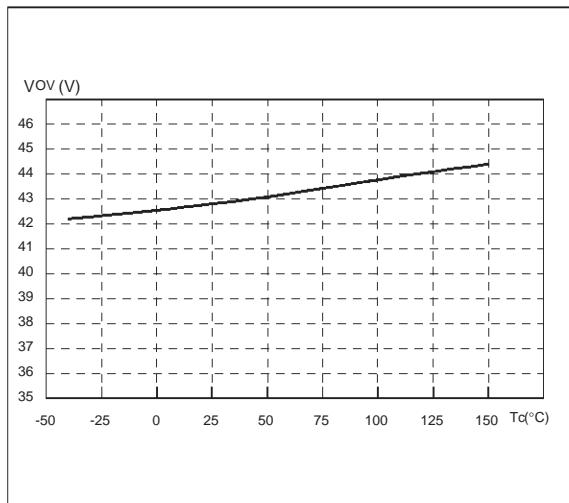


Input Hysteresis Voltage

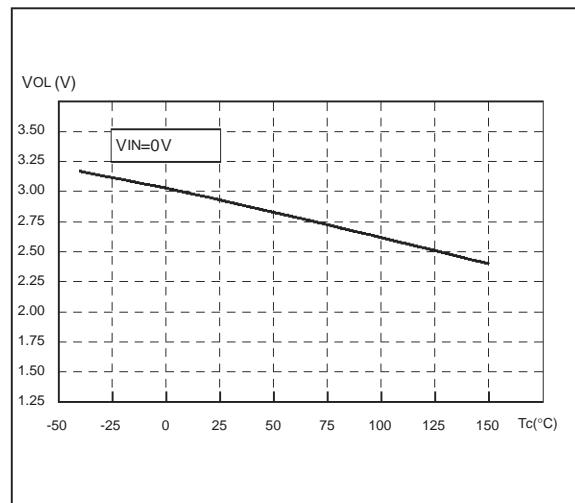


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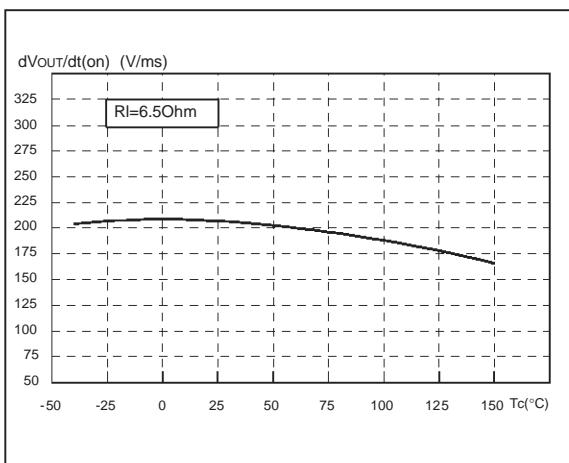
### Overvoltage Shutdown



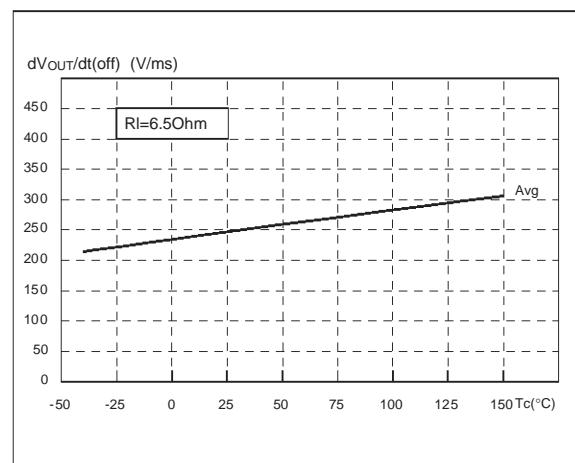
### Openload Off State Voltage Detection Threshold



### Turn-on Voltage Slope

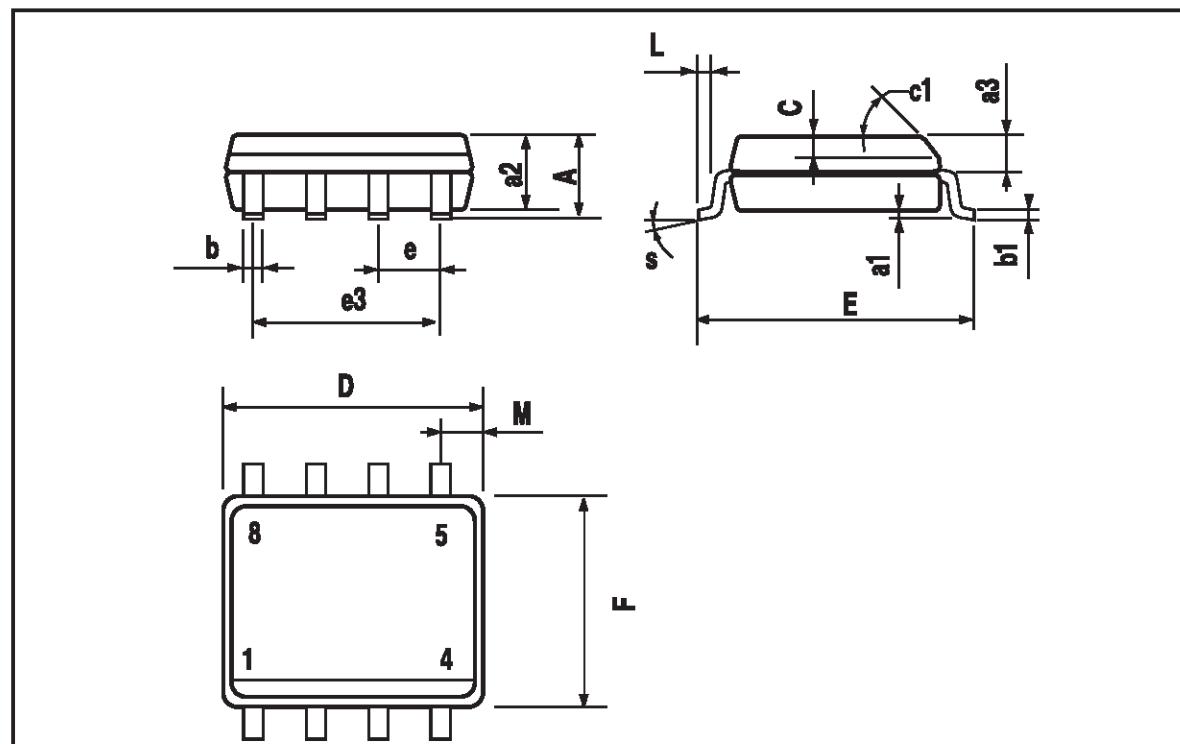


### Turn-off Voltage Slope



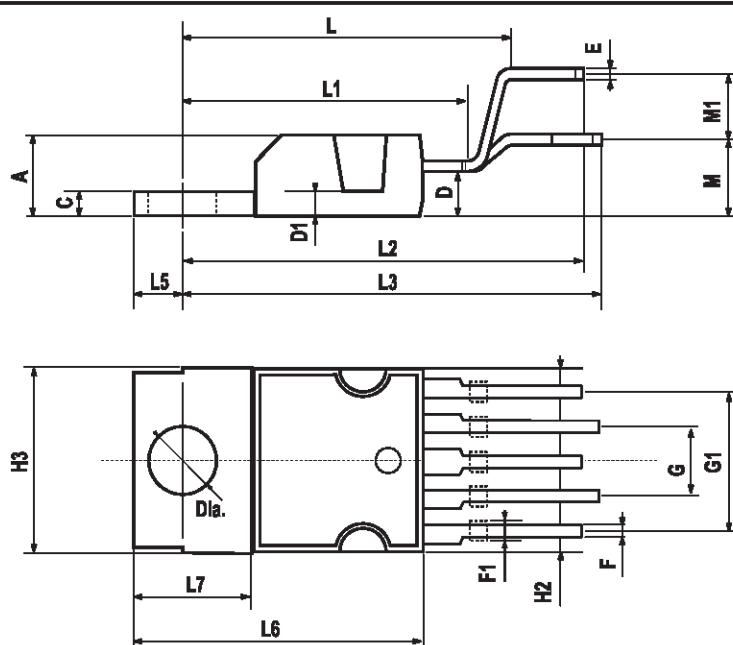
**SO-8 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1		45 (typ.)				
D	4.8		5	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S		8 (max.)				
L1	0.8		1.2	0.031		0.047



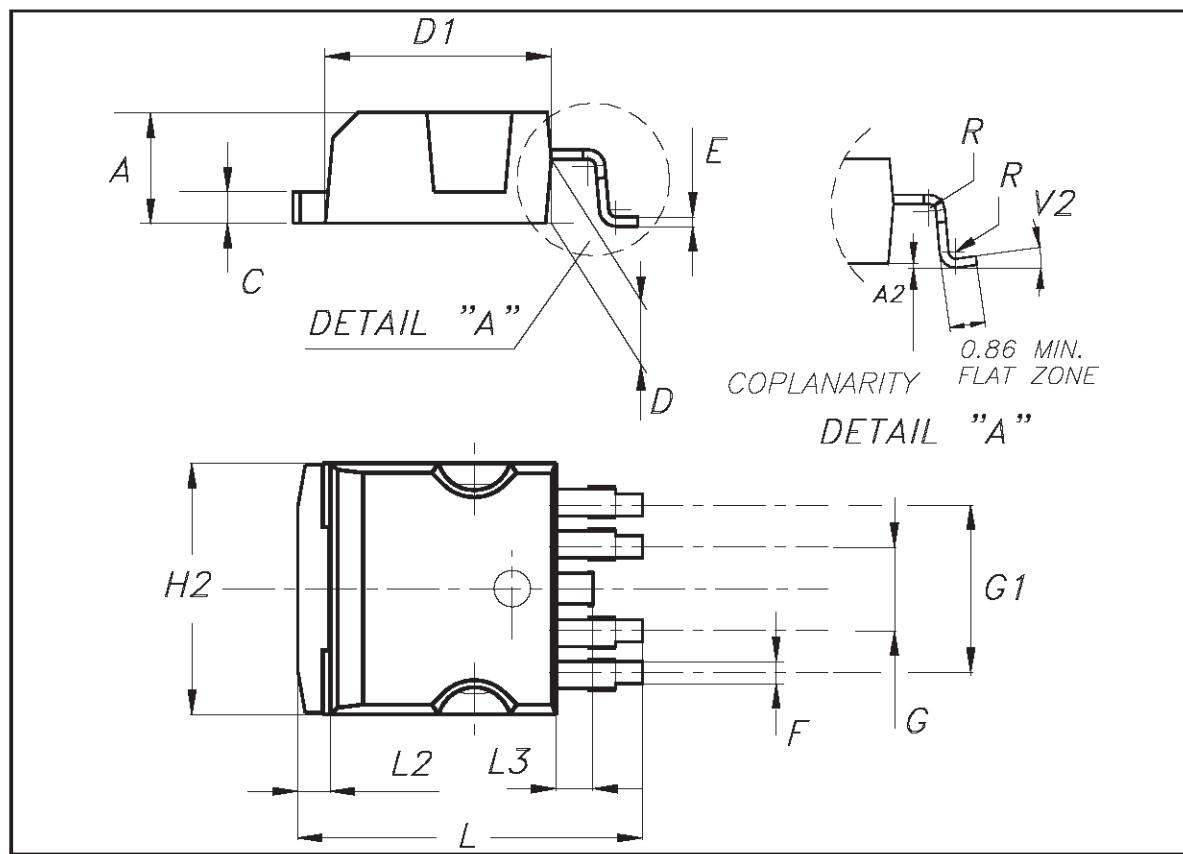
**PENTAWATT (VERTICAL) MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			4.8			0.189
C			1.37			0.054
D	2.4		2.8	0.094		0.110
D1	1.2		1.35	0.047		0.053
E	0.35		0.55	0.014		0.022
F	0.8		1.05	0.031		0.041
F1	1		1.4	0.039		0.055
G	3.2	3.4	3.6	0.126	0.134	0.142
G1	6.6	6.8	7	0.260	0.268	0.276
H2			10.4			0.409
H3	10.05		10.4	0.396		0.409
L		17.85			0.703	
L1		15.75			0.620	
L2		21.4			0.843	
L3		22.5			0.886	
L5	2.6		3	0.102		0.118
L6	15.1		15.8	0.594		0.622
L7	6		6.6	0.236		0.260
M		4.5			0.177	
M1		4			0.157	
Diam.	3.65		3.85	0.144		0.152



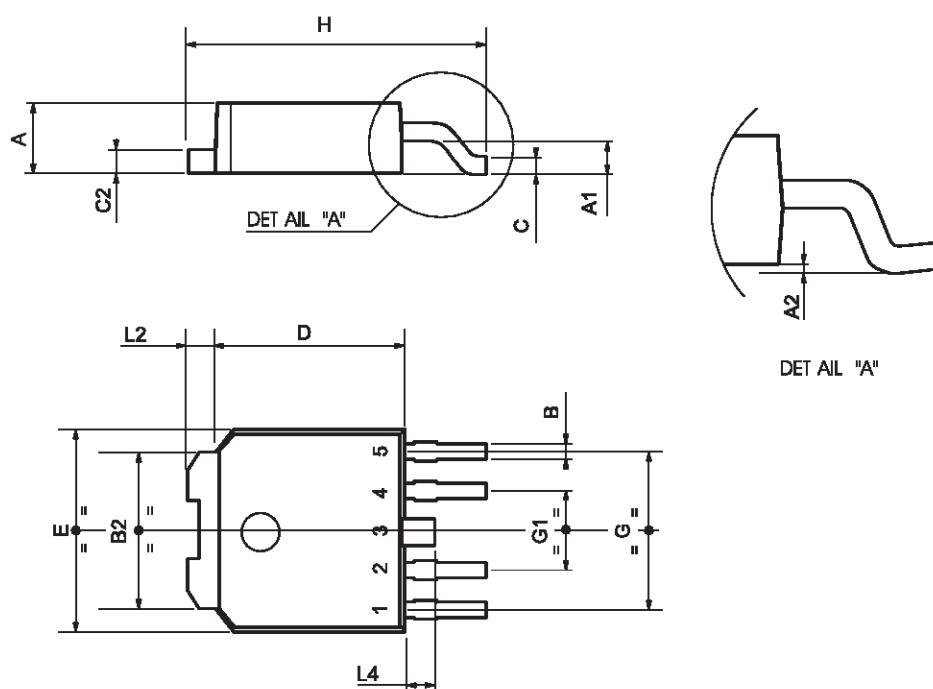
**P<sup>2</sup>PAK MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.30		4.80	0.169		0.189
A2	0.03		0.23	0.001		0.009
C	1.17		1.37	0.046		0.054
D	2.40		2.80	0.094		0.110
D1	8.95		9.35	0.352		0.368
E	0.35		0.55	0.014		0.022
F	0.80		1.05	0.031		0.041
G	3.20		3.60	0.126		0.142
G1	6.60		7.00	0.260		0.276
H2			10.40			0.409
L	13.59		14.39	0.535		0.567
L2	1.27		1.40	0.050		0.055
L3	1.30		1.70	0.051		0.067
R		0.30			0.012	
V2	0 d		8 d			



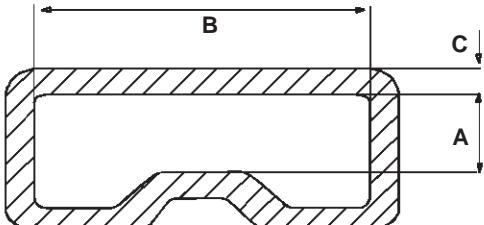
**PAAK MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.009
B	0.4		0.6	0.015		0.023
B2	5.2		5.4	0.204		0.212
C	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.9		5.25	0.193		0.206
G1	2.38		2.7	0.093		0.106
H	9.35		10.1	0.368		0.397
L2		0.8	1		0.031	0.039
L4	0.6		1	0.031		0.039



## VN750 / VN750S / VN750PT / VN750-B5

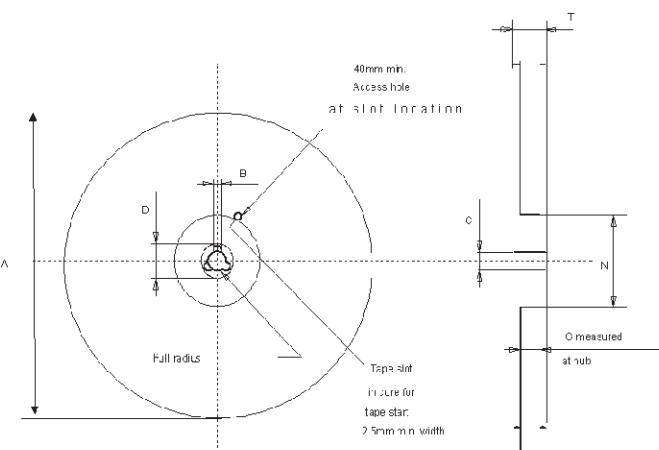
### SO-8 TUBE SHIPMENT (no suffix)



<b>Base Q.ty</b>	100
<b>Bulk Q.ty</b>	2000
<b>Tube length (<math>\pm 0.5</math>)</b>	532
<b>A</b>	3.2
<b>B</b>	6
<b>C (<math>\pm 0.1</math>)</b>	0.6

All dimensions are in mm.

### TAPE AND REEL SHIPMENT (suffix "13TR")



REEL DIMENSIONS	
<b>Base Q.ty</b>	2500
<b>Bulk Q.ty</b>	2500
<b>A (max)</b>	330
<b>B (min)</b>	1.5
<b>C (<math>\pm 0.2</math>)</b>	13
<b>F</b>	20.2
<b>G (<math>+2/-0</math>)</b>	12.4
<b>N (min)</b>	60
<b>T (max)</b>	18.4

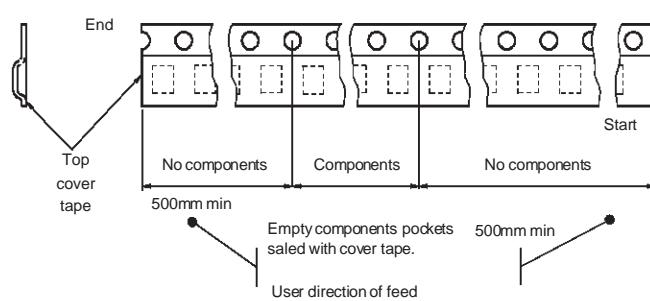
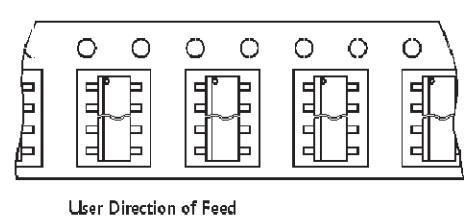
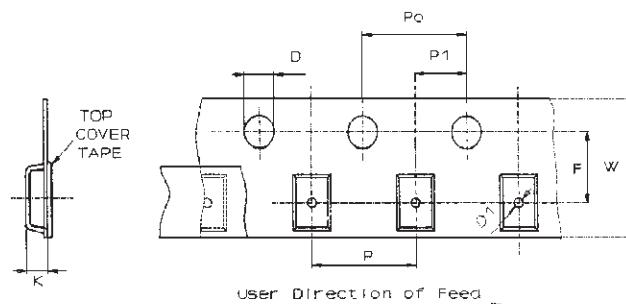
All dimensions are in mm.

### TAPE DIMENSIONS

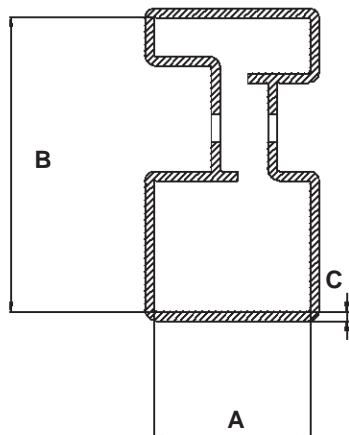
According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb 1986

<b>Tape width</b>	<b>W</b>	12
<b>Tape Hole Spacing</b>	<b>P0 (<math>\pm 0.1</math>)</b>	4
<b>Component Spacing</b>	<b>P</b>	8
<b>Hole Diameter</b>	<b>D (<math>\pm 0.1/-0</math>)</b>	1.5
<b>Hole Diameter</b>	<b>D1 (min)</b>	1.5
<b>Hole Position</b>	<b>F (<math>\pm 0.05</math>)</b>	5.5
<b>Compartment Depth</b>	<b>K (max)</b>	4.5
<b>Hole Spacing</b>	<b>P1 (<math>\pm 0.1</math>)</b>	2

All dimensions are in mm.



**PENTAWATT TUBE SHIPMENT (no suffix)**

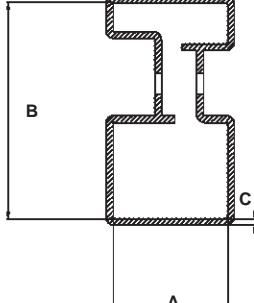


<b>Base Q.ty</b>	50
<b>Bulk Q.ty</b>	1000
<b>Tube length (<math>\pm 0.5</math>)</b>	532
<b>A</b>	18
<b>B</b>	33.1
<b>C (<math>\pm 0.1</math>)</b>	1

All dimensions are in mm.

## VN750 / VN750S / VN750PT / VN750-B5

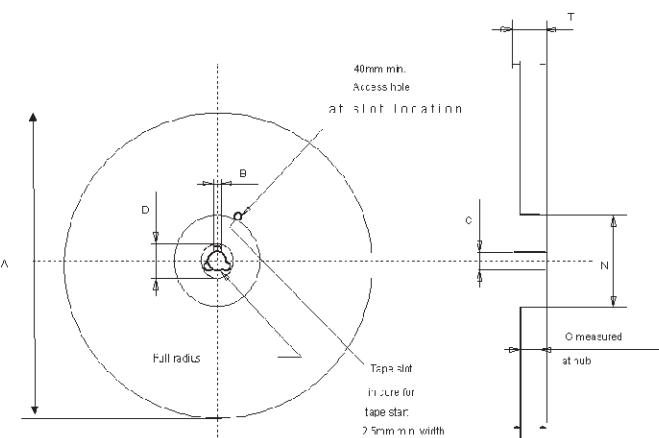
### P<sup>2</sup>PAK TUBE SHIPMENT (no suffix)



<b>Base Q.ty</b>	50
<b>Bulk Q.ty</b>	1000
<b>Tube length (<math>\pm 0.5</math>)</b>	532
<b>A</b>	18
<b>B</b>	33.1
<b>C (<math>\pm 0.1</math>)</b>	1

All dimensions are in mm.

### TAPE AND REEL SHIPMENT (suffix "13TR")



REEL DIMENSIONS	
<b>Base Q.ty</b>	1000
<b>Bulk Q.ty</b>	1000
<b>A (max)</b>	330
<b>B (min)</b>	1.5
<b>C (<math>\pm 0.2</math>)</b>	13
<b>F</b>	20.2
<b>G (+ 2 / -0)</b>	24.4
<b>N (min)</b>	60
<b>T (max)</b>	30.4

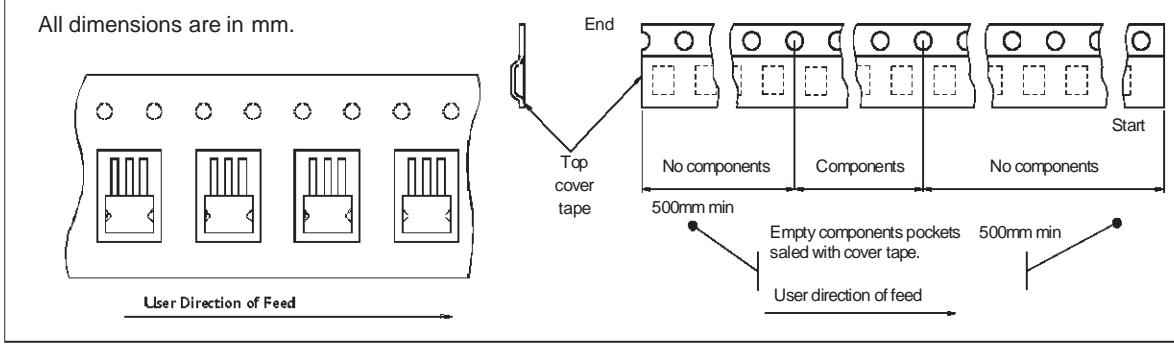
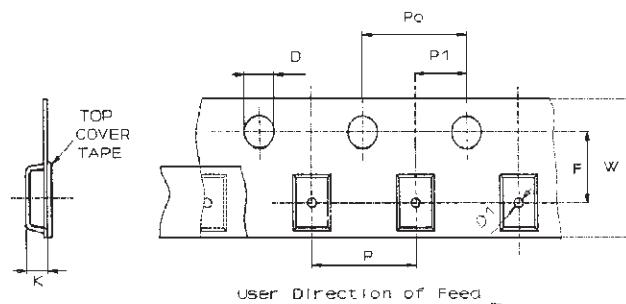
All dimensions are in mm.

### TAPE DIMENSIONS

According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb 1986

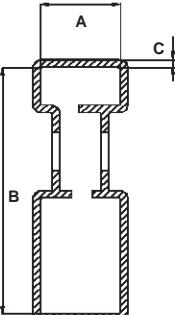
<b>Tape width</b>	<b>W</b>	24
<b>Tape Hole Spacing</b>	<b>P0 (<math>\pm 0.1</math>)</b>	4
<b>Component Spacing</b>	<b>P</b>	16
<b>Hole Diameter</b>	<b>D (<math>\pm 0.1/-0</math>)</b>	1.5
<b>Hole Diameter</b>	<b>D1 (min)</b>	1.5
<b>Hole Position</b>	<b>F (<math>\pm 0.05</math>)</b>	11.5
<b>Compartment Depth</b>	<b>K (max)</b>	6.5
<b>Hole Spacing</b>	<b>P1 (<math>\pm 0.1</math>)</b>	2

All dimensions are in mm.

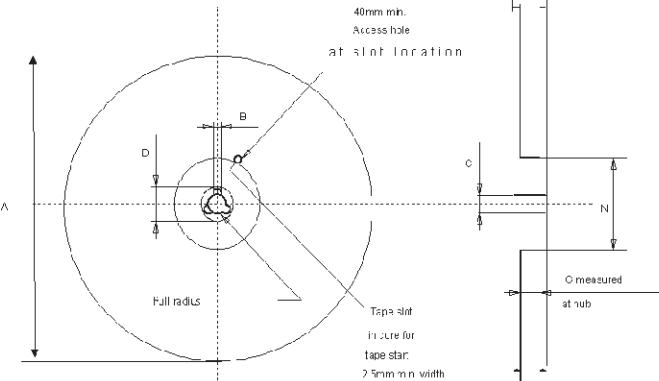


## VN750 / VN750S / VN750PT / VN750-B5

### PPAK TUBE SHIPMENT (no suffix)

	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td>Base Q.ty</td><td>75</td></tr> <tr><td>Bulk Q.ty</td><td>3000</td></tr> <tr><td>Tube length (<math>\pm 0.5</math>)</td><td>532</td></tr> <tr><td>A</td><td>6</td></tr> <tr><td>B</td><td>21.3</td></tr> <tr><td>C (<math>\pm 0.1</math>)</td><td>0.6</td></tr> </table>	Base Q.ty	75	Bulk Q.ty	3000	Tube length ( $\pm 0.5$ )	532	A	6	B	21.3	C ( $\pm 0.1$ )	0.6
Base Q.ty	75												
Bulk Q.ty	3000												
Tube length ( $\pm 0.5$ )	532												
A	6												
B	21.3												
C ( $\pm 0.1$ )	0.6												
All dimensions are in mm.													

### TAPE AND REEL SHIPMENT (suffix "13TR")

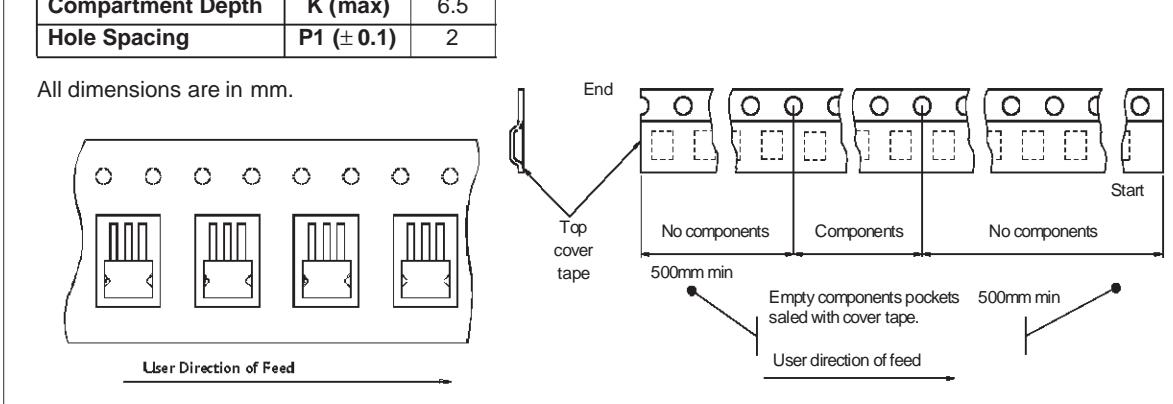
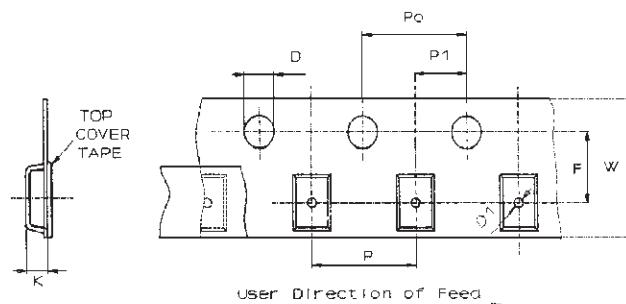
	<p><b>REEL DIMENSIONS</b></p> <table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td>Base Q.ty</td><td>2500</td></tr> <tr><td>Bulk Q.ty</td><td>2500</td></tr> <tr><td>A (max)</td><td>330</td></tr> <tr><td>B (min)</td><td>1.5</td></tr> <tr><td>C (<math>\pm 0.2</math>)</td><td>13</td></tr> <tr><td>F</td><td>20.2</td></tr> <tr><td>G (<math>+2/-0</math>)</td><td>16.4</td></tr> <tr><td>N (min)</td><td>60</td></tr> <tr><td>T (max)</td><td>22.4</td></tr> </table>	Base Q.ty	2500	Bulk Q.ty	2500	A (max)	330	B (min)	1.5	C ( $\pm 0.2$ )	13	F	20.2	G ( $+2/-0$ )	16.4	N (min)	60	T (max)	22.4
Base Q.ty	2500																		
Bulk Q.ty	2500																		
A (max)	330																		
B (min)	1.5																		
C ( $\pm 0.2$ )	13																		
F	20.2																		
G ( $+2/-0$ )	16.4																		
N (min)	60																		
T (max)	22.4																		
All dimensions are in mm.																			

### TAPE DIMENSIONS

According to Electronic Industries Association  
(EIA) Standard 481 rev. A, Feb 1986

<b>Tape width</b>	<b>W</b>	16
<b>Tape Hole Spacing</b>	<b>P0 (<math>\pm 0.1</math>)</b>	4
<b>Component Spacing</b>	<b>P</b>	8
<b>Hole Diameter</b>	<b>D (<math>\pm 0.1/-0</math>)</b>	1.5
<b>Hole Diameter</b>	<b>D1 (min)</b>	1.5
<b>Hole Position</b>	<b>F (<math>\pm 0.05</math>)</b>	7.5
<b>Compartment Depth</b>	<b>K (max)</b>	6.5
<b>Hole Spacing</b>	<b>P1 (<math>\pm 0.1</math>)</b>	2

All dimensions are in mm.



## **VN750 / VN750S / VN750PT / VN750-B5**

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